

IXTP10P15T-VB Datasheet P-Channel 150 V (D-S) MOSFET

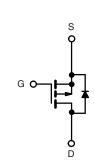
PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω) I _D (A)		Q _g (Typ.)		
- 150	0.100 at V _{GS} = - 10 V	- 20	13.7		
- 150	0.120 at V_{GS} = - 4.5 V	- 18	10.7		

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % R_g and UIS Tested
 Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- DC/DC Converters



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_{\rm C}$ = 25 °C, unless oth	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 150	v	
Gate-Source Voltage		V _{GS}	± 20	- V
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _C = 25 °C	1-	- 20	
	T _C = 70 °C	I _D	- 16	^
Pulsed Drain Current	I _{DM}	- 60	- A	
Avalanche Current	I _{AS}	- 18		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	17.2	mJ
	T _C = 25 °C	P	37.1 ^b	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D –	2.5	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

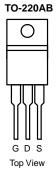
THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	50	°C/W	
Junction-to-Case (Drain)	R _{thJC}	3.9	0/10	

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).





COMPLIANT HALOGEN FREE



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•	· · · ·					
Drain-Source Breakdown Voltage	V _{DS} V _{DS} = 0 V, I _D = - 250 μA - 150				v		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1		- 2.5	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 150 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μA	
		$V_{DS} = -150 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 10 V, V_{GS} = - 10 V	- 20			А	
	Б	V _{GS} = - 10 V, I _D = - 5.0A		0.100			
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 4.0 A		0.120		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 5.0 A		12		S	
Dynamic ^b	•	·		•			
Input Capacitance	C _{iss}			1055		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 75 V, f = 1 MHz		65			
Reverse Transfer Capacitance	C _{rss}			41			
Tatal Cata Charma ⁶	Qg	$V_{DS} = -75V, V_{GS} = -10V, I_{D} = -5.0A$		23.2	34.8	nC	
Total Gate Charge ^c				13.7	19.6		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = - 75 V, V_{GS} = - 4.5 V, I_{D} = - 5.0 A		4.5			
Gate-Drain Charge ^c	Q _{gd}			5.8			
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω	
Turn-On Delay Time ^c	t _{d(on)}			7	14		
Rise Time ^c	t _r	V_{DD} = - 75 V, R _L = 17.2 Ω		12	18	- ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 2.9 A, V_{GEN} = - 10 V, R_g = 1 Ω		33	50		
Fall Time ^c	t _f			9	18		
Drain-Source Body Diode Ratings and	nd Characteri	stics T _C = 25 °C ^b					
Continuous Current	ا _S				- 8.8		
Pulsed Current	I _{SM}				- 15	A	
Forward Voltage ^a	V _{SD}	$I_{F} = -2.9 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.5	V	
Reverse Recovery Time	t _{rr}			50	75	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	А	
Reverse Recovery Charge	Q _{rr}	1 1		98	147	nC	

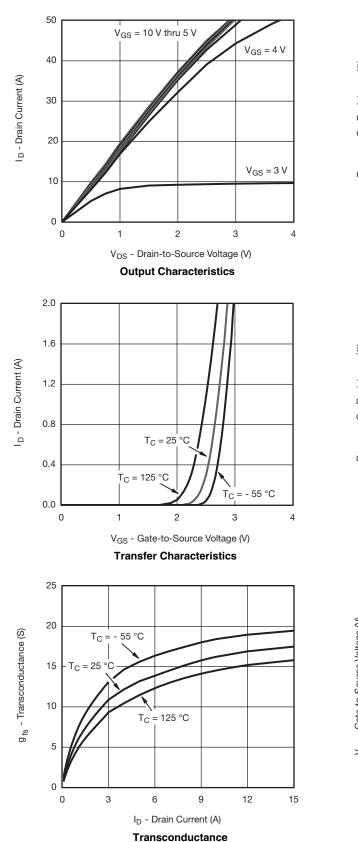
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

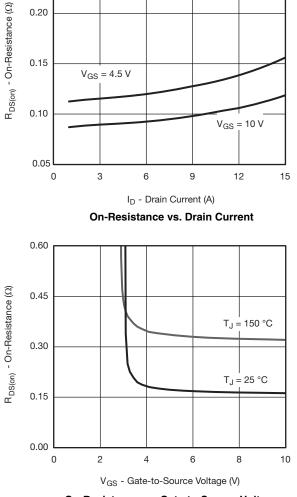
b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





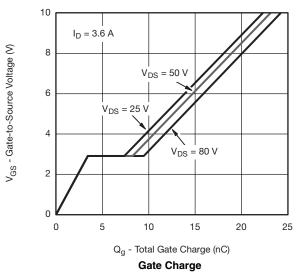
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



0.25

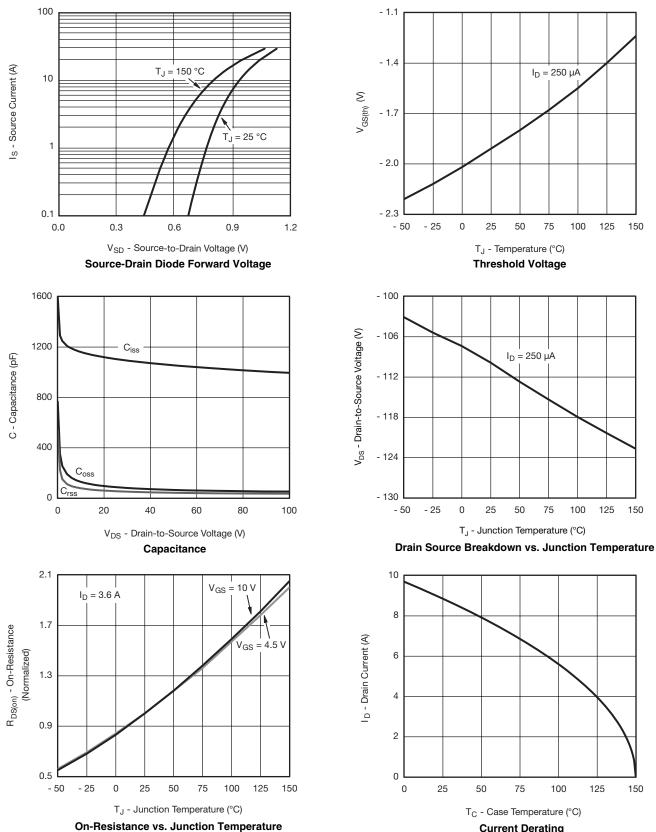
0.20

On-Resistance vs. Gate-to-Source Voltage





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

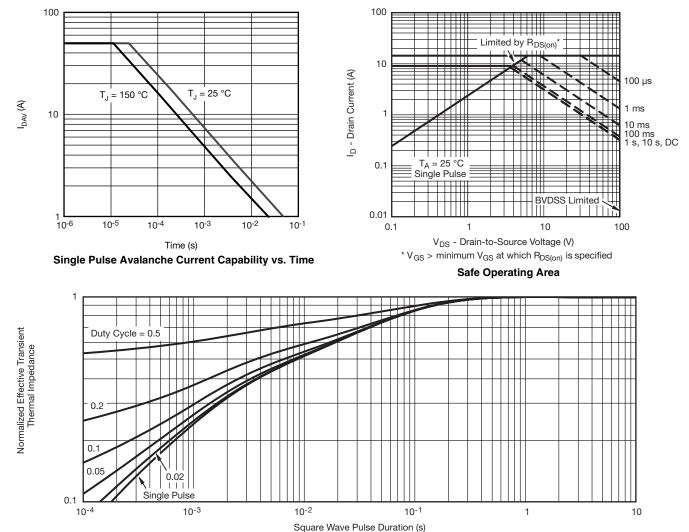


服务热线:400-655-8788

Current Derating



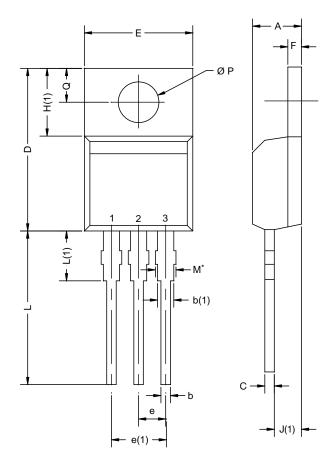
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220AB



	MILLIM	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: X12-0208-Rev. N, 08-Oct-12 DWG: 5471					

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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